# 2.5V Drive Nch MOS FET

# **RJK005N03**

#### ●Structure

Silicon N-channel MOS FET

## ● Features

- 1) Low On-resistance.
- 2) Low voltage drive (2.5V drive).

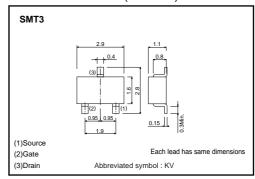
## Applications

Switching

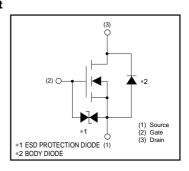
# ●Packaging specifications and hFE

	Package	Taping
Туре	Code	T146
	Basic ordering unit (pieces)	3000
RJK005N03	0	

# ●External dimensions (Unit : mm)



#### •Inner circuit



# ● Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		VDSS	30	V
Gate-source voltage		Vgss	±12	V
Drain current	Continuous	ID	±500	mA
	Pulsed	IDP *1	±2.0	Α
Source current	Continuous	Is	200	mA
(Body Diode)	Pulsed	Isp *1	800	mA
Total power dissipation		Pp *2	200	mW
Channel temperature		Tch	150	°C
Range of storage temperature		Tstg -55 to +15		°C

## ●Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth(ch-a)*	625	°C/W

<sup>\*</sup> Each terminal mounted on a recommended land

<sup>\*1</sup> Pw≤10µs, Duty cycle≤1% \*2 Each terminal mounted on a recommended land

# ●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	1	_	±10	μΑ	Vgs=±12V, Vps=0V
Drain-source breakdown voltage	V <sub>(BR) DSS</sub>	30	_	_	V	I <sub>D</sub> = 1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	IDSS	-	_	1	μΑ	V <sub>DS</sub> = 30V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS (th)</sub>	8.0	_	1.5	V	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA
Static drain-source on-state resistance		_	400	580	mΩ	I <sub>D</sub> = 500mA, V <sub>GS</sub> = 4.5V
	R <sub>DS (on)</sub> *	-	420	600	mΩ	I <sub>D</sub> = 500mA, V <sub>GS</sub> = 4V
		-	650	940	mΩ	I <sub>D</sub> = 500mA, V <sub>GS</sub> = 2.5V
Forward transfer admittance	Y <sub>fs</sub>   *	0.5	-	_	S	V <sub>DS</sub> = 10V, I <sub>D</sub> = 500mA
Input capacitance	Ciss	-	60	_	pF	V <sub>DS</sub> = 10V
Output capacitance	Coss	_	24	_	pF	Vgs=0V
Reverse transfer capacitance	Crss	_	12	_	pF	f=1MHz
Turn-on delay time	t <sub>d (on)</sub> *	-	9	_	ns	V <sub>DD</sub> ≒ 15V
Rise time	tr *	-	11	_	ns	ID= 250mA
Turn-off delay time	t <sub>d (off)</sub> *	_	16	_	ns	V <sub>GS</sub> = 4V R <sub>L</sub> =60Ω
Fall time	t <sub>f</sub> *	-	31	_	ns	R <sub>G</sub> =10Ω
Total gate charge	Qg *	_	2.0	4.0	nC	V <sub>DD</sub> ≒24V
Gate-source charge	Q <sub>gs</sub> *	_	0.6	_	nC	V <sub>GS</sub> = 4V
Gate-drain charge	Q <sub>gd</sub> *	_	0.7	-	nC	I <sub>D</sub> = 500mA

\*Pulsed

# ●Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp*	_	_	1.2	V	I <sub>S</sub> = 500mA, V <sub>GS</sub> =0V

\*Pulsed

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